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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/773,809	02/05/2004	Kazuya Fujita	60803(49381)	8452	
7590 07/23/2007 DAVID G. CONLIN, ESQ.			EXAM	EXAMINER	
EDWARDS & ANGELL, LLP P.O. BOX 55874			LOUIE, WAI SING		
BOSTON, MA 02205			ART UNIT	PAPER NUMBER	
			2814		
			MAIL DATE	DELIVERY MODE	
			07/23/2007	PAPER	

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

1		Application No.	Applicant(s)			
		10/773,809	FUJITA ET AL.			
Office Action Summary		Examiner	Art Unit			
		Wai-Sing Louie	2814			
	The MAILING DATE of this communication app	1	·			
Period fo	r Reply					
WHIC - Exter after - If NO - Failu Any r	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DATE in a sions of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. Period for reply is specified above, the maximum statutory period were to reply within the set or extended period for reply will, by statute, eply received by the Office later than three months after the mailing ad patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim vill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	I. nely filed the mailing date of this communication. D (35 U.S.C. § 133).			
Status	:					
1)⊠	Responsive to communication(s) filed on 15 Ju	ine 2007.				
2a)⊠	This action is <b>FINAL</b> . 2b) This action is non-final.					
3)	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
	closed in accordance with the practice under E	x parte Quayle, 1935 C.D. 11, 45	53 O.G. 213.			
Dispositi	on of Claims					
5)□ 6)⊠ 7)□	Claim(s) 1-16,30-38 and 48-51 is/are pending if 4a) Of the above claim(s) is/are withdraw Claim(s) is/are allowed.  Claim(s) 1-16,30-38 and 48-51 is/are rejected.  Claim(s) is/are objected to.  Claim(s) are subject to restriction and/or	vn from consideration.				
Applicati	on Papers	•				
9) 10)	The specification is objected to by the Examine The drawing(s) filed on is/are: a) access applicant may not request that any objection to the Replacement drawing sheet(s) including the correction to the other contents. The oath or declaration is objected to by the Examine The specific acceptance of the specific	epted or b) objected to by the Idrawing(s) be held in abeyance. See ion is required if the drawing(s) is obj	e 37 CFR 1.85(a). lected to. See 37 CFR 1.121(d).			
Priority u	ınder 35 U.S.C. § 119					
12)⊠ a)[	Acknowledgment is made of a claim for foreign  All b) Some * c) None of:  Certified copies of the priority documents  Certified copies of the priority documents  Copies of the certified copies of the prior  application from the International Bureau  See the attached detailed Office action for a list	s have been received. s have been received in Applicati rity documents have been receive a (PCT Rule 17.2(a)).	on No ed in this National Stage			
Attachmen	t(s)		•			
1) Notice 2) Notice 3) Inform	te of References Cited (PTO-892) te of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO/SB/08) or No(s)/Mail Date 6/15/07	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:	ate			

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## **DETAILED ACTION**

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-16, 30-38, and 48-51 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hashimoto (US Pub. 2003/0123779) in view of Beyne et al. (US 6,566,745).

With regard to claims 1, 6, and 11, Hashimoto discloses an optical device (paragraph [0026] et seq. and fig. 8) comprising:

- A solid state image pickup device 50 having an effective pixel region 14 in one surface (paragraph [0085] and fig. 2);
- A light-transparent cover 32 arranged opposite to the effective pixel region 14 and having planner dimensions smaller than those of the solid state image pickup device 50 (paragraph [0088] and fig. 4a);
- An adhesive section 36 for adhering the solid state image pickup device 14 and the light-transparent cover 32 (paragraph [0089] and fig. 4a);
- Connection terminals 26 disposed on the solid state image pickup device 50, the adhering section 36 disposed at least in a portion of a region where the cover opposes the pickup device 14 and such that the connect terminals 26 are exposed (fig. 5a).

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Hashimoto does not disclose a space is formed between the effective pixel region and the light-transparent cover. However, Beyne et al. disclose a space between the effective pixel region 52 and the light-transparent cover 51 (Hashimoto fig. 5i). Beyne et al. provide a motivation to combine with Hashimoto, which is the space between the effective pixel region and the light-transparent cover could be used for the wire bonding of the effective pixel region to the chip I/O pads (Beyne col. 7, lines 38-42). Thus, it would have been obvious at the time the invention was made to modify Hashimoto's device with the teaching of Beyne et al. to provide a space between the effective pixel region and the light-transparent cover in order to use the space for the wire bonding of the effective pixel region to the chip I/O pads.

With regard to claims 2, 8, 10, 12, and 48, Hashimoto discloses the adhering section 36 contains photosensitive (resin) adhesive (paragraph [0089]).

With regard to claims 3-5, 9, 13-15, 35, and 51, Hashimoto discloses a space is formed between the effective pixel region 14 and the light-transparent cover 32 (fig. 4a), and where the adhering section 58 is formed outside effective pixel region 14 in the one surface of the solid state image pickup device 50 sealing the outer periphery of the space (fig. 8).

With regard to claim 7, Hashimoto discloses the light-transparent plate 30 is divided so as to form light-transparent covers 32 each having planar dimensions smaller than those of the solid-state image pickup device 14 (fig. 3b).

With regard to claim 16, in addition to the limitations disclosed in claims 1, 6, and 11 above, Hashimoto also discloses:

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• A lens retainer 74 for retaining the lens 78 (fig. 9);

• The light-transparent cover is arranged opposite to the lens and inside the lens retainer (fig. 8 and fig. 10).

With regard to claim 30, in addition to the limitations disclosed in claims 1, 6, 11, and 16 above, Hashimoto also discloses:

• A wiring board 62 on which wiring 54 is formed (paragraph [0109] and fig. 8).

With regard to claims 31 and 38, Hashimoto discloses the optical path-defining unit 70 retains a lens 78 arranged opposite to the light-transparent cover 32 of the solid-state image pickup device 50 (fig. 9).

With regard to claims 32 and 36-37, in addition to the limitations disclosed in claims 1, 6, 11, 16, and 30 above, Hashimoto also discloses:

- A solid state imaging module component (fig. 8) formed by resin-sealing 58: a
   module component wiring board 62 on which wiring 54 is formed (fig. 8);
- The solid-state image pickup device 50 is electrically connected to the wiring 54 in a state that the surface of the light-transparent cover 32 is exposed (fig. 8).

With regard to claim 33, Hashimoto discloses an external terminal 60 connected to the wiring 54 on the surface of the module component wiring board 62 reverse to the surface to which the imaging device 50 is adhered (fig. 8).

With regard to claim 34, Hashimoto discloses the external terminal has a protruding shape (fig. 8).

With regard to claim 49, Hashimoto discloses the adhering section 36 contains photosensitive (thermoplastic photosensitive resin) adhesive (paragraph [0089]).

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With regard to claim 50, Hashimoto discloses the light-transparent cover 30 is planar (fig. 3a and 3b).

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## Response to Arguments

Applicant's arguments filed 6/15/2007 have been fully considered but they are not persuasive.

Applicant argues that Hashimoto does not disclose no gap provided between the
adhesive layer 36 and the optical region 14. However, Beyne et al. disclose such a
gap between the effective pixel region and the light-transparent cover. The
combination of Hashimoto and Beyne et al. meet the amended independent
claims.

## Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event,

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however, will the statutory period for reply expire later than SIX MONTHS from the date of this

final action.

Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Wai-Sing Louie whose telephone number is (571) 272-1709. The

examiner can normally be reached on 7:30 AM to 4:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Wael Fahmy can be reached on (571) 272-1705. The fax phone number for the

organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent

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July 18, 2007.